E4M0015075K1

Silicon Carbide Power MOSFET
E-Series Automotive
N-Channel Enhancement Mode

Features

- Optimized package with separate driver source pin
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

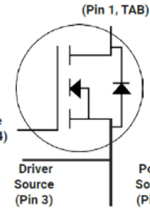
Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package



Part Number	Package	Marking
E4M0015075K1	TO-247-4L	E4M0015075K1

Maximum Ratings (T_C = 25 ˚C unless otherwise specified)

Symbol	Parameter		Value	Unit	Note
V_{DSmax}	Drain - Source Voltage		750	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
I_D	Continuous Drain Current, V_{GS} = 15 V	T_C = 25˚C	128	A	Fig. 19 Note: 2
		T_C = 100˚C	95		
$I_{D(pulse)}$	Pulsed Drain Current, Pulse width t_P limited by T_{jmax}		418	A	Fig. 22
P_D	Power Dissipation, T_C=25˚C, T_J = 175 ˚C		372	W	Fig. 20 Note: 2
T_J , T_{stg}	Operating Junction and Storage Temperature		-40 to +175	˚C	
T_L	Solder Temperature, 1.6mm (0.063”) from case for 10s		260	˚C	
M_d	Mounting Torque , M3 or 6-32 screw		1 8.8	Nm lbf-in	

Note (1): Recommended turn off / turn on gate voltage V_{GS} - 4V...0V / +15V
Note (2): Verified by design

Electrical Characteristics (T_C = 25˚C unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	750			V	V_{GS} = 0 V, I_D = 100 μA	
$V_{GS(th)}$	Gate Threshold Voltage	1.8	2.6	3.8	V	V_{DS} = V_{GS}, I_D = 15.4 mA	Fig. 11
			2.0		V	V_{DS} = V_{GS}, I_D = 15.4 mA, T_J = 175ºC	
I_{DSS}	Zero Gate Voltage Drain Current		1	50	μA	V_{DS} = 750 V, V_{GS} = 0 V	
I_{GSS}	Gate-Source Leakage Current		10	250	nA	V_{GS} = 15 V, V_{DS} = 0 V	
$R_{DS(on)}$	Drain-Source On-State Resistance		15	21	mΩ	V_{GS} = 15 V, I_D = 55.8 A	Fig. 4, 5, 6
			22			V_{GS} = 15 V, I_D = 55.8 A, T_J = 175ºC	
g_{fs}	Transconductance		42		S	V_{DS}= 20 V, I_{DS}= 55.8 A	Fig. 7
			42			V_{DS}= 20 V, I_{DS}= 55.8 A, T_J = 175°C	
C_{iss}	Input Capacitance		5128		pF	V_{GS} = 0 V, V_{DS} = 0V to 500 V F = 100 kHz V_{AC} = 25 mV	Fig. 17, 18
C_{oss}	Output Capacitance		255				
C_{rss}	Reverse Transfer Capacitance		23				
E_{oss}	C_{oss} Stored Energy		45		μJ		Fig. 16
$C_{o(er)}$	Effective Output Capacitance (Energy Related)		326		pF	V_{GS} = 0 V, V_{DS} = 0... 500V	Note: 3
$C_{o(tr)}$	Effective Output Capacitance (Time Related)		469		pF		
E_{ON}	Turn-On Switching Energy (External Diode)		258		μJ	V_{DS}= 500 V, V_{GS}= -4 V/15 V, I_D= 55.8 A, $R_{G(ext)}$ = 2.5 Ω, L= 59 μH, T_J = 175ºC FWD = External SiC DIODE	Fig. 26, 28
E_{OFF}	Turn Off Switching Energy (External Diode)		203				
E_{ON}	Turn-On Switching Energy (Body Diode FWD)		374		μJ	V_{DS}= 500 V, V_{GS}= -4 V/15 V, I_D= 55.8 A, $R_{G(ext)}$ = 2.5 Ω, L= 59 μH, T_J = 175ºC FWD = Internal Body Diode	Fig. 26, 28
E_{OFF}	Turn-Off Switching Energy (Body Diode FWD)		178				
$t_{d(on)}$	Turn-On Delay Time		16		ns	V_{DD} = 500 V, V_{GS} = -4 V/15 V I_D = 55.8 A, $R_{G(ext)}$ = 2.5 Ω, Timing relative to V_{DS} Inductive load	Fig. 27, 28
t_r	Rise Time		23				
$t_{d(off)}$	Turn-Off Delay Time		42				
t_f	Fall Time		12				
$R_{G(int)}$	Internal Gate Resistance		2.1		Ω	f = 1 MHz, V_{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		51		nC	V_{DS} = 500 V, V_{GS} = -4 V/15 V I_D = 55.8 A Per IEC60747-8-4 pg 21	Fig. 12
Q_{gd}	Gate to Drain Charge		58				
Q_g	Total Gate Charge		191				

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 500V
$C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 500V

Reverse Diode Characteristics (T_C = 25˚C unless otherwise specified)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_{SD}	Diode Forward Voltage	4.9		V	V_{GS} = -4 V, I_{SD} = 27.9 A, T_J = 25 °C	Fig. 8, 9, 10
		4.4		V	V_{GS} = -4 V, I_{SD} = 27.9 A, T_J = 175 °C	
I_S	Continuous Diode Forward Current		67	A	V_{GS} = -4 V, T_C = 25˚C	
$I_{S, pulse}$	Diode pulse Current		418.5	A	V_{GS} = -4 V, pulse width t_P limited by T_{jmax}	
t_{rr}	Reverse Recover time	23		ns	V_{GS} = -4 V, I_{SD} = 55.8 A, V_R = 500 V dif/dt = 7590 A/µs, T_J = 175 °C	
Q_{rr}	Reverse Recovery Charge	1017		nC		
I_{rrm}	Peak Reverse Recovery Current	75		A		
t_{rr}	Reverse Recover time	29		ns	V_{GS} = -4 V, I_{SD} = 55.8 A, V_R = 500 V dif/dt = 2620 A/µs, T_J = 175 °C	
Q_{rr}	Reverse Recovery Charge	619		nC		
I_{rrm}	Peak Reverse Recovery Current	36		A		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.29	0.4	°C/W		Fig. 21

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Typical Performance

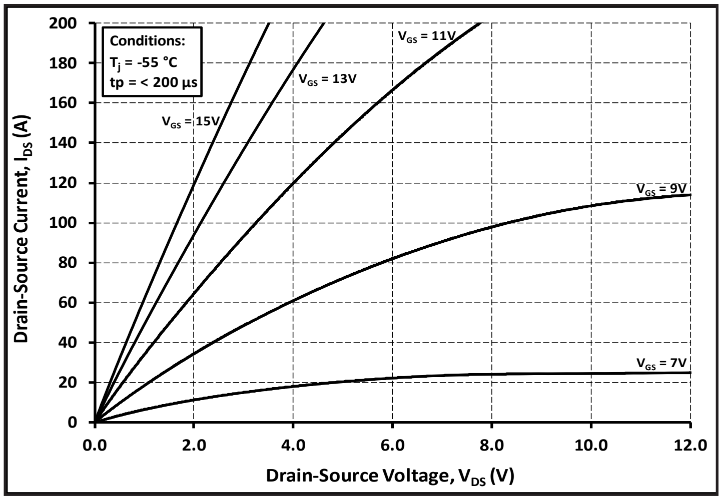

Figure 1. Output Characteristics T_J = -55 °C

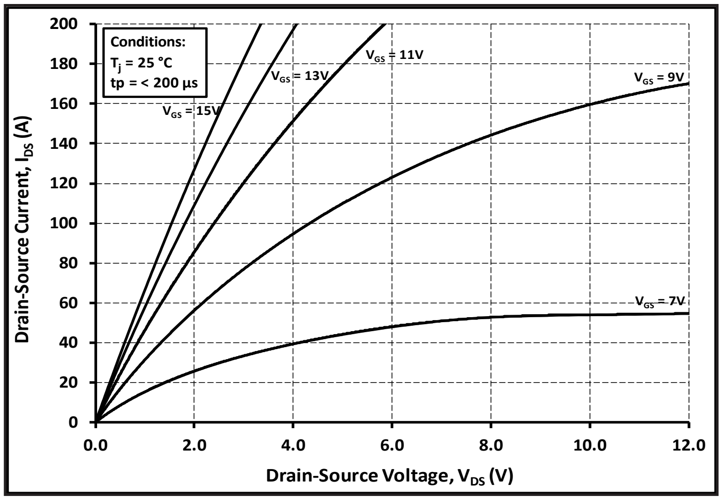

Figure 2. Output Characteristics T_J = 25 °C

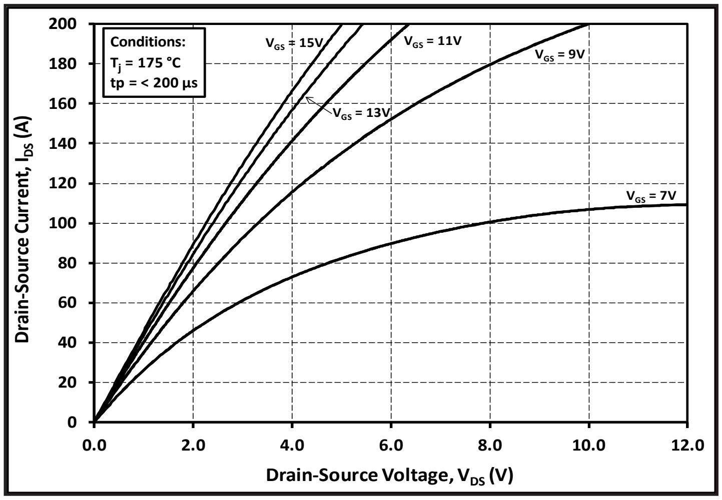

Figure 3. Output Characteristics T_J = 175 °C

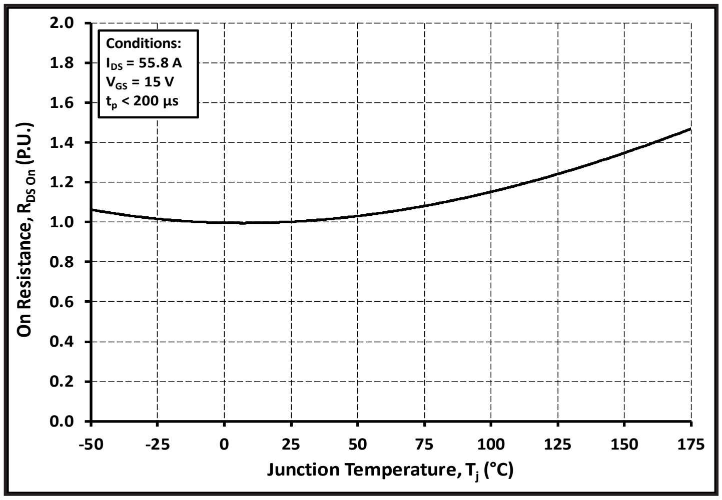

Figure 4. Normalized On-Resistance vs. Temperature

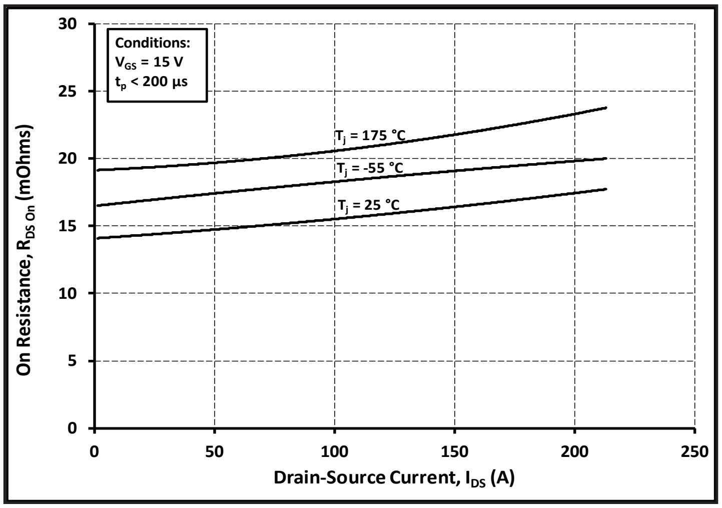

Figure 5. On-Resistance vs. Drain Current
For Various Temperatures

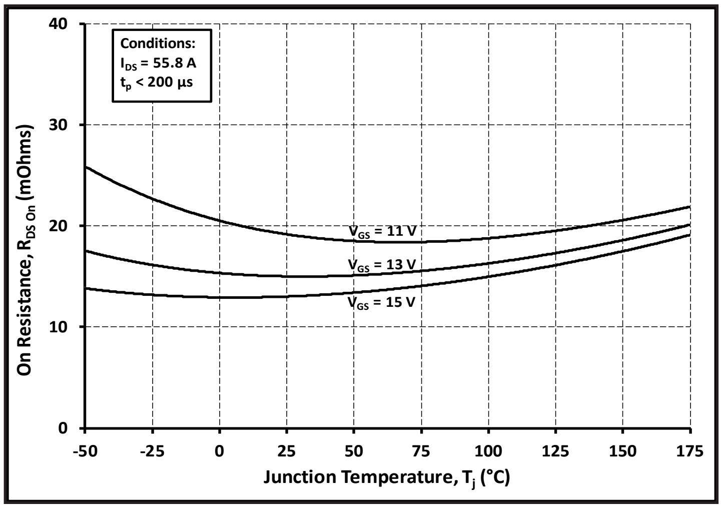

Figure 6. On-Resistance vs. Temperature
For Various Gate Voltage

Typical Performance

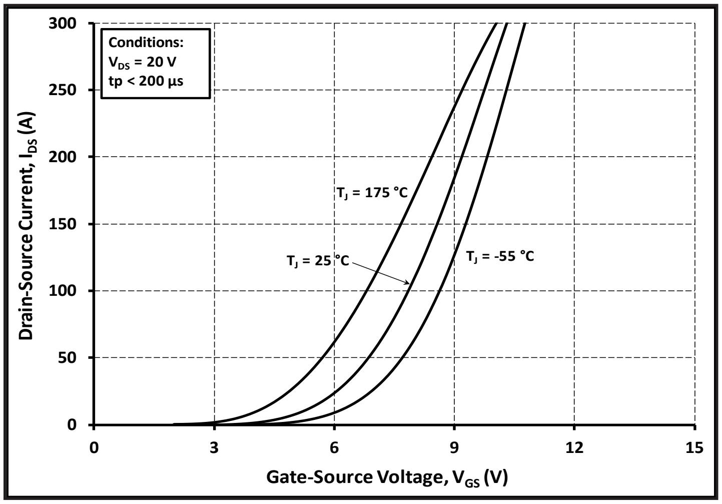

Figure 7. Transfer Characteristic for Various Junction Temperatures

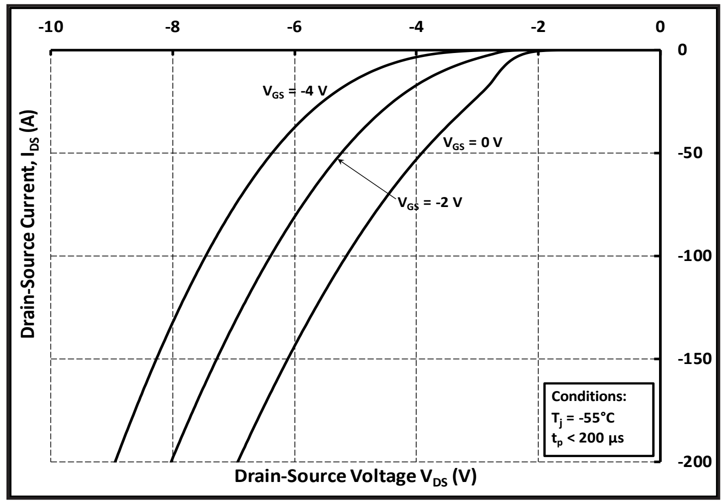

Figure 8. Body Diode Characteristic at -55 °C

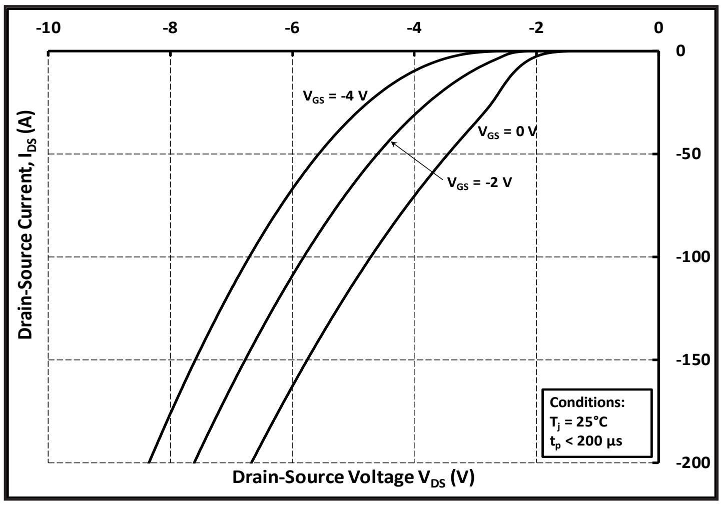

Figure 9. Body Diode Characteristic at 25 °C

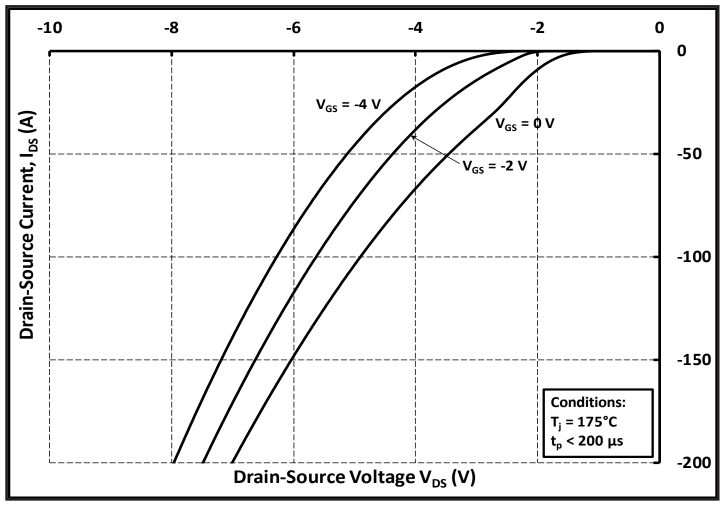

Figure 10. Body Diode Characteristic at 175 °C

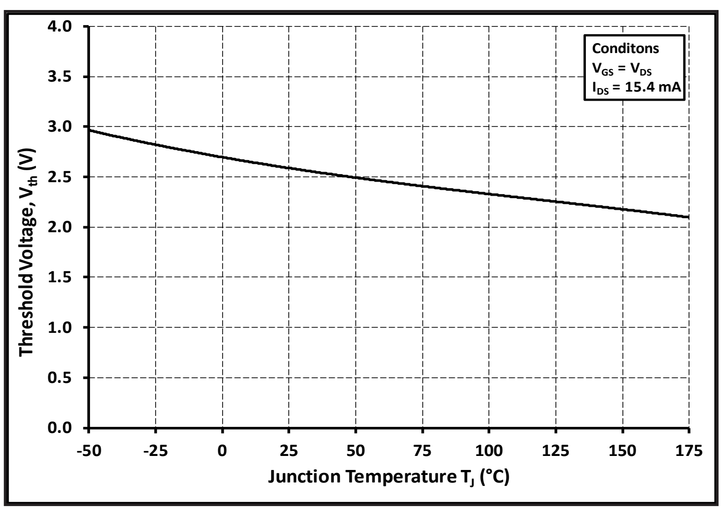

Figure 11. Threshold Voltage vs. Temperature

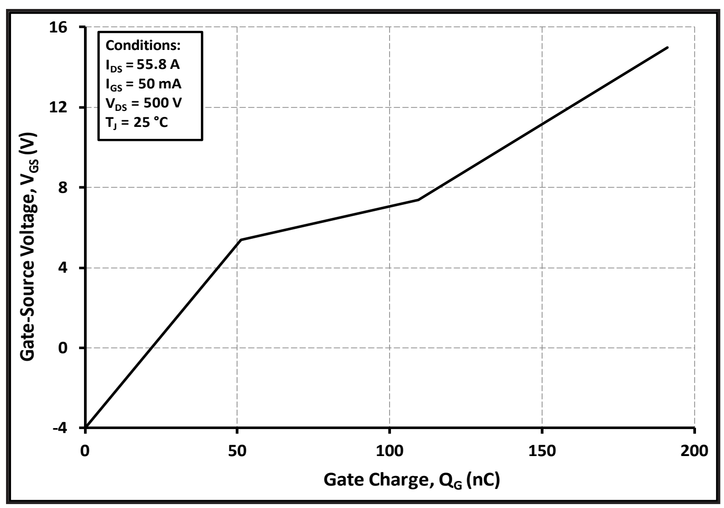

Figure 12. Gate Charge Characteristics

Typical Performance

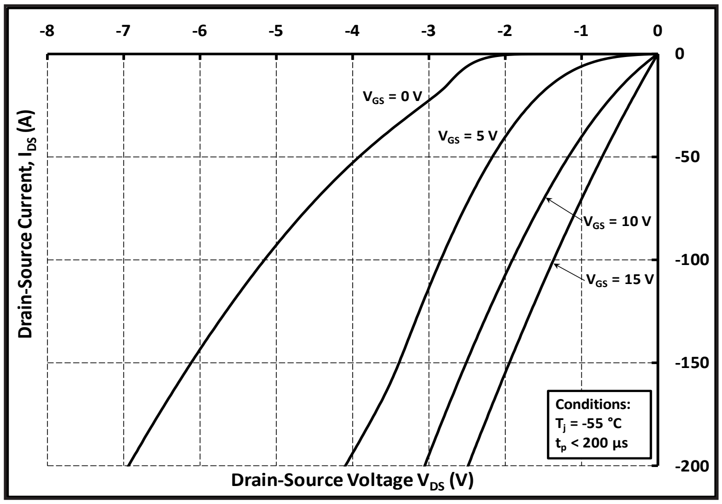

Figure 13. 3rd Quadrant Characteristic at -55 °C

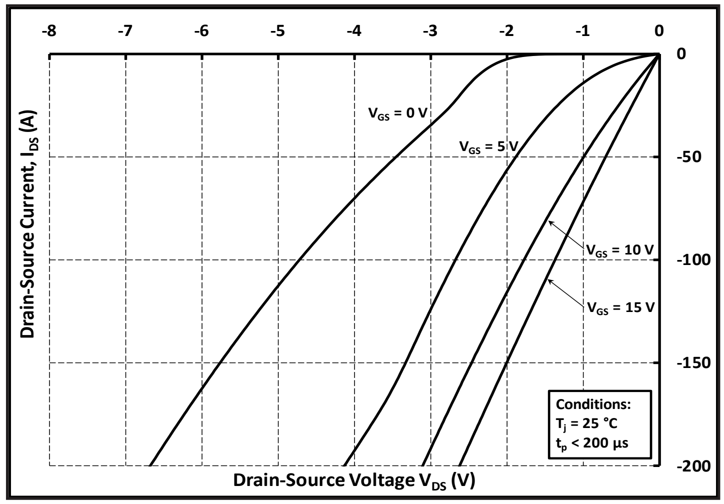

Figure 14. 3rd Quadrant Characteristic at 25 °C

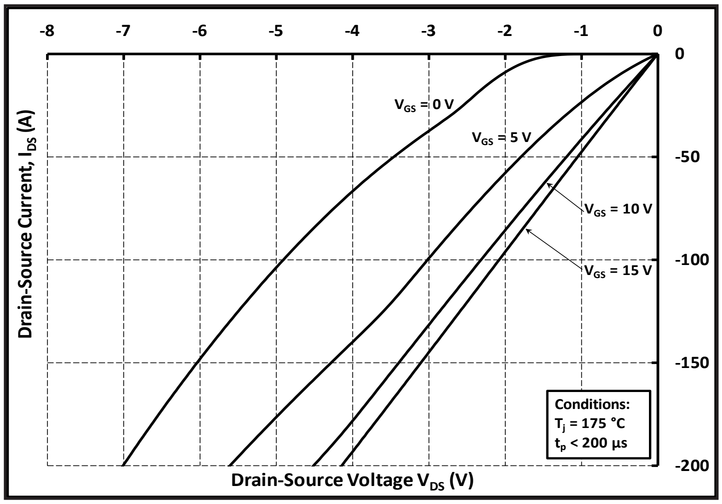

Figure 15. 3rd Quadrant Characteristic at 175 °C

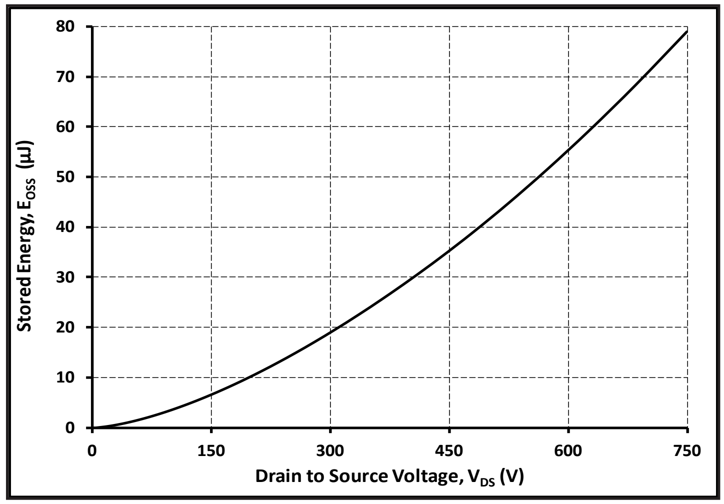

Figure 16. Output Capacitor Stored Energy

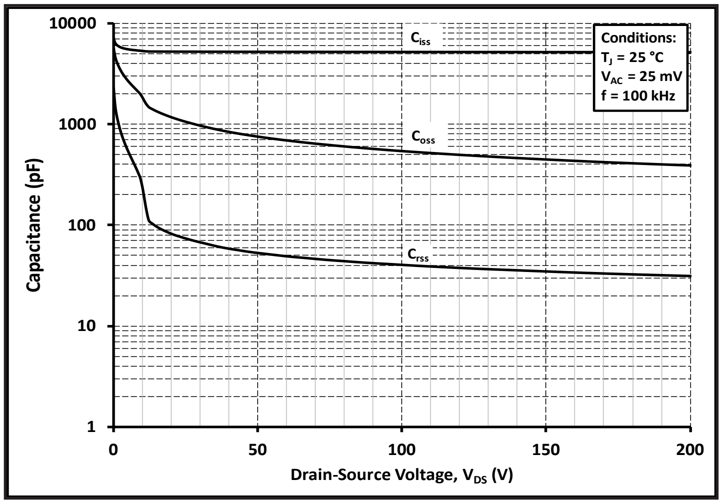

Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

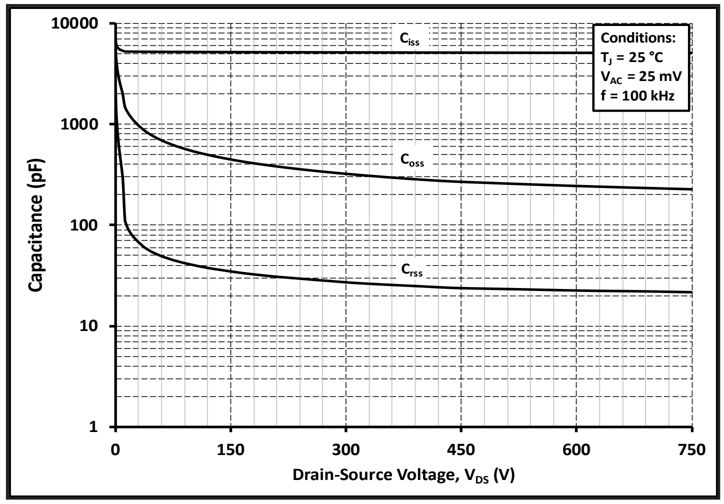

Figure 18. Capacitances vs. Drain-Source Voltage (0 - 750V)

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Typical Performance

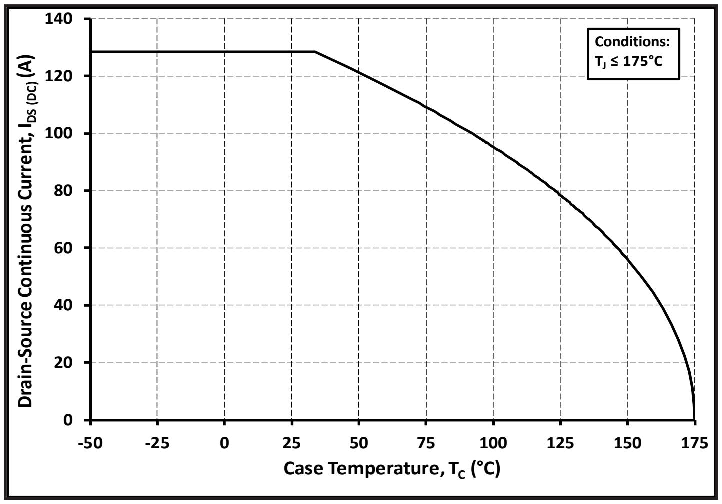


Figure 19. Continuous Drain Current Derating vs. Case Temperature

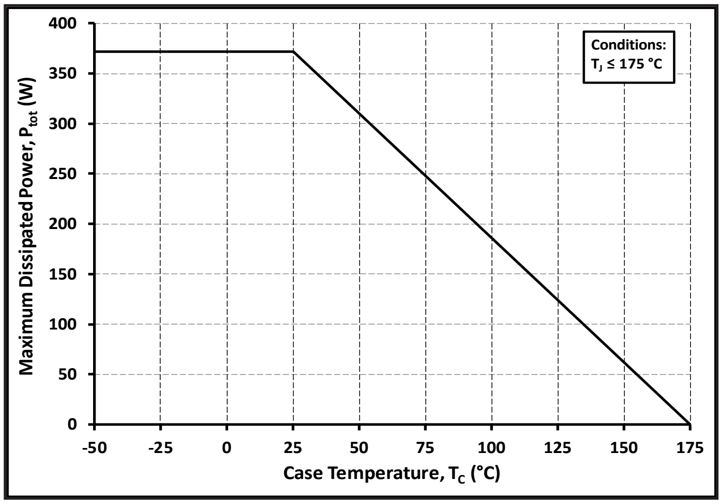


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

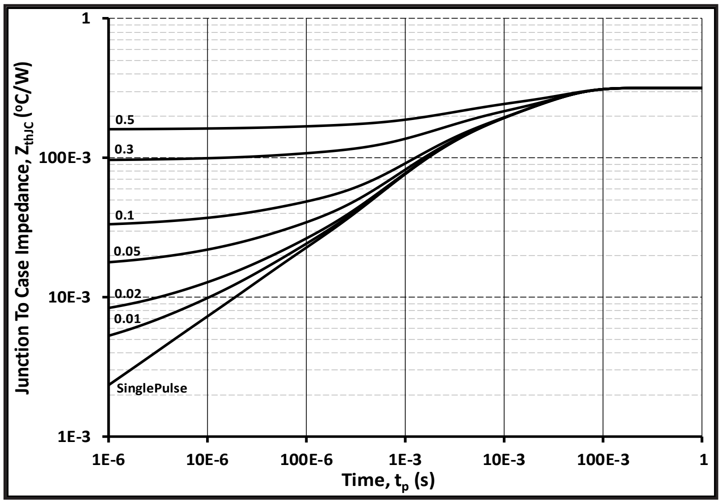


Figure 21. Transient Thermal Impedance (Junction - Case)

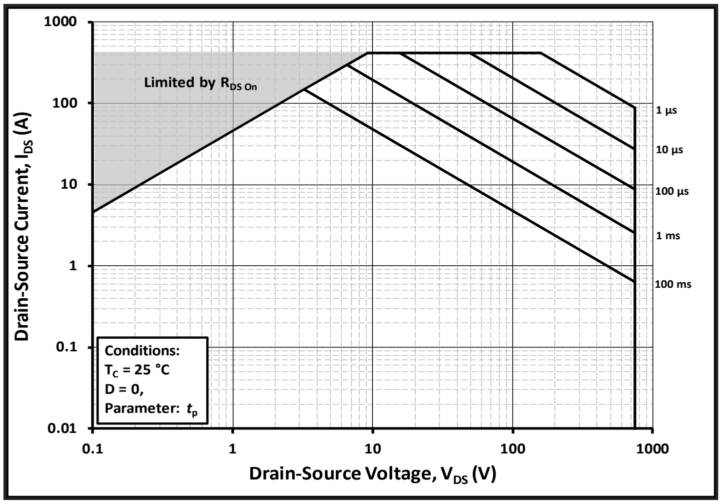


Figure 22. Safe Operating Area

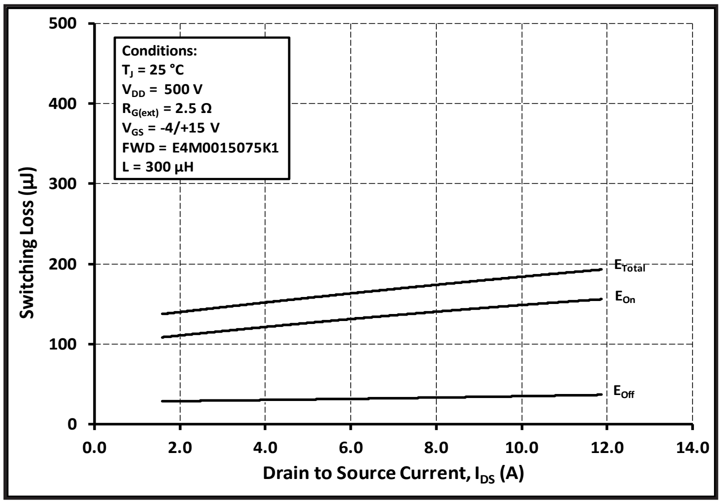


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 500V)

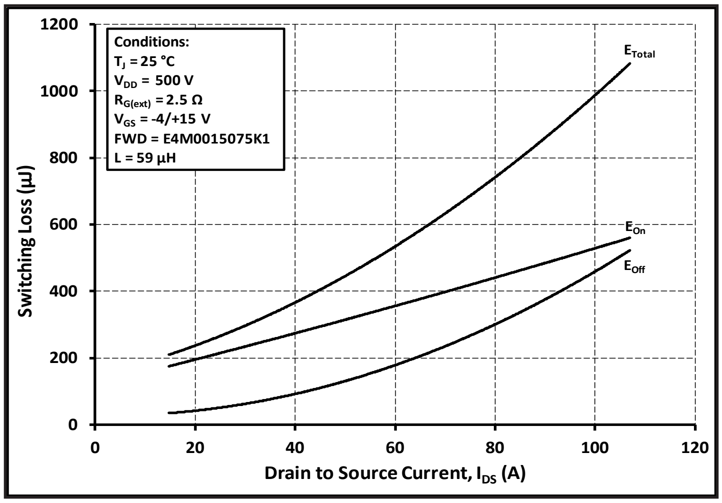


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 500V)

Typical Performance

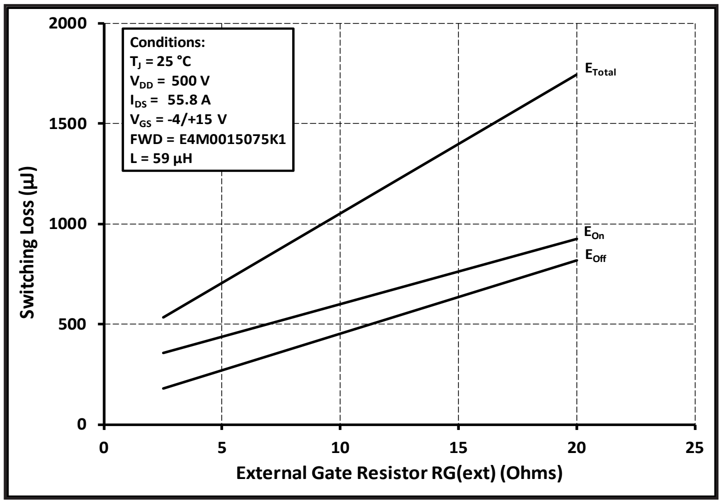


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

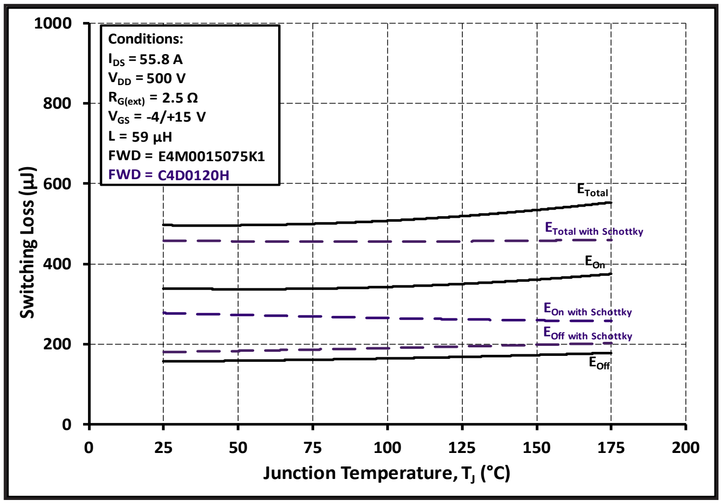


Figure 26. Clamped Inductive Switching Energy vs. Temperature

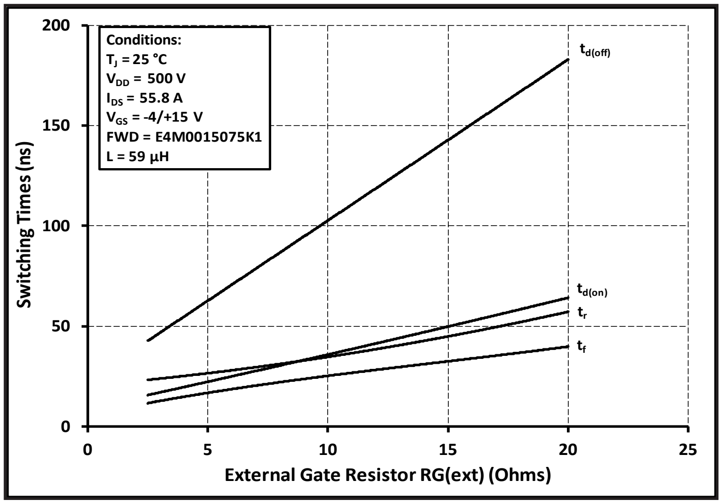


Figure 27. Switching Times vs. $R_{G(ext)}$

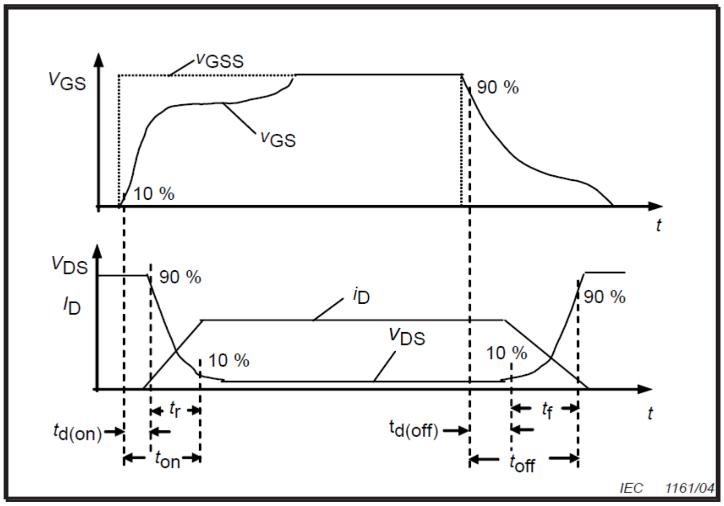


Figure 28. Switching Times Definition

Test Circuit Schematic

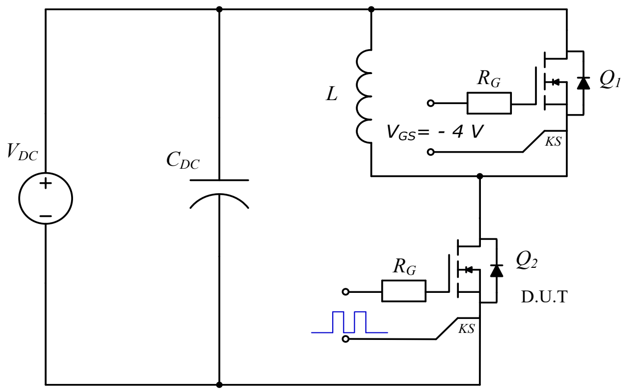
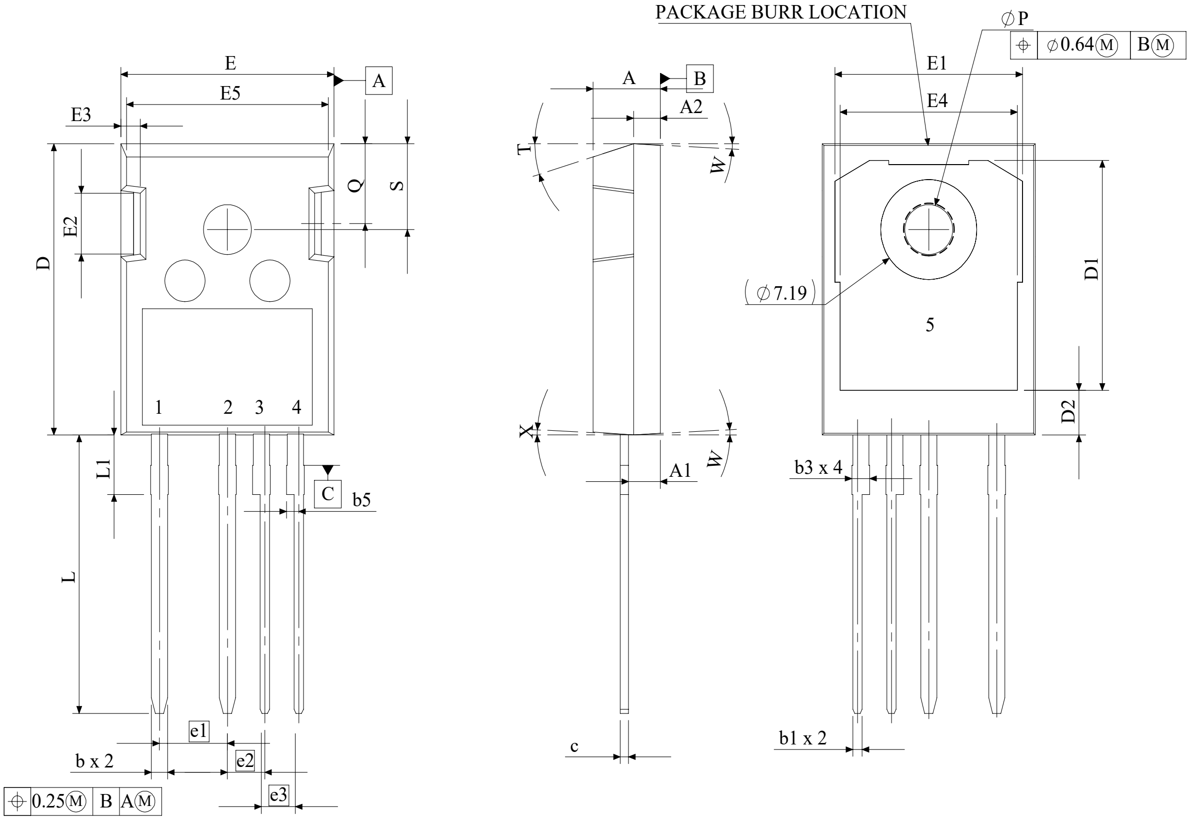


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



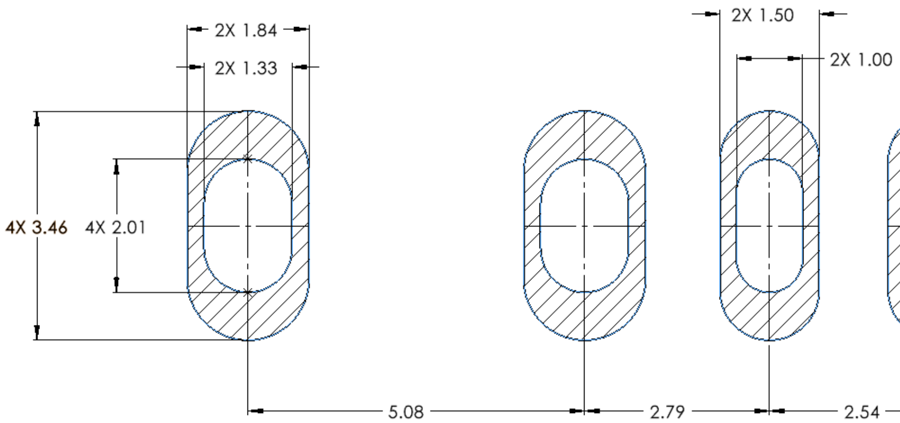
SYMBOL	MIN (mm)	MAX (mm)
A	4.83	5.21
A1	2.22	2.6
A2	1.91	2.16
b	1.10	1.30
b1	0.65	0.79
b3	1.34	1.44
b5	0.74	1.14
c	0.55	0.68
D	20.76	21.14
D1	16.25	17.65
D2	2.95	3.35
E	15.75	16.13
E1	13.1	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
E5	14.65	15.05
e1	5.08 BSC	
e2	2.79 BSC	
e3	2.54 BSC	
L	19.72	20.32
L1	3.87	4.47
∅P	3.51	3.65
Q	5.49	6.00
S	6.04	6.30
T	17.5° REF.	
W	3.5° REF.	
X	4° REF.	

1	DRAIN
2	SOURCE
3	DRIVER SOURCE
4	GATE
5	DRAIN

NOTE:
1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
4. BURR OR MOLD FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version	Date of release	Descriptiion of changes
1.0	November-2023	Initial datasheet
2.0	January-2024	Corrected typo on Temperature range
3	January - 2025	Legal Disclaimer updated

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REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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